

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TMCS1123A1AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A1AQ1
TMCS1123A1AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A1AQ1
TMCS1123A2AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A2AQ1
TMCS1123A2AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A2AQ1
TMCS1123A3AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A3AQ1
TMCS1123A3AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A3AQ1
TMCS1123A4AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A4AQ1
TMCS1123A4AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A4AQ1
TMCS1123A5AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A5AQ1
TMCS1123A5AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123A5AQ1
TMCS1123B1AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B1AQ1
TMCS1123B1AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B1AQ1
TMCS1123B2AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B2AQ1
TMCS1123B2AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B2AQ1
TMCS1123B3AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B3AQ1
TMCS1123B3AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B3AQ1
TMCS1123B4AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B4AQ1
TMCS1123B4AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B4AQ1
TMCS1123B5AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B5AQ1
TMCS1123B5AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123B5AQ1
TMCS1123C1AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C1AQ1
TMCS1123C1AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C1AQ1
TMCS1123C2AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C2AQ1
TMCS1123C2AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C2AQ1
TMCS1123C3AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C3AQ1
TMCS1123C3AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C3AQ1
TMCS1123C4AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C4AQ1
TMCS1123C4AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C4AQ1
TMCS1123C5AQDVGRQ1	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C5AQ1

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TMCS1123C5AQDVGRQ1.A	Active	Production	SOIC (DVG) 10	2000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	1123C5AQ1

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF TMCS1123-Q1 :

- Catalog : [TMCS1123](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product